

L Number	Hits	Search Text	DB	Time stamp
1	2	6287890.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:15
8	2	5509553.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:28
15	3	"semi-additive plating".ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:31
22	129	(semi-additive with plating).detd.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:32
29	40	(semi-additive with (plating and copper)).detd.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:49
36	23	((semi-additive with (plating and copper)).detd.) and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:02
43	4614	"EDM"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:57
50	758	"EDM" same laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:58
57	617	"EDM" with laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:58
64	1	6287890.pn. and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:15
71	1	6287890.pn. and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:23
78	1	6093476.pn. and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:24
92	1	6093476.pn. and laser and semi-additive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 16:24

-	65797	"glass transition temperature" or "T.sub.g"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 10:45
-	7468	("glass transition temperature" or "T.sub.g") and (expansion or expansivity)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 10:51
-	135	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and ((disk or hard) adj1 drive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 14:04
-	9	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and gimbal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 10:53
-	142	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and ((disk or hard) adj1 drive)) or (((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and gimbal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 11:09
-	1991	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 14:07
-	785	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 11:10
-	214	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and (disk or head)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 11:16
-	16	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and semi-additive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:03
-	1	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and (disk or head)) and semi-additive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 11:22
-	1	5970319.pn. and steel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:02
-	2	5509553.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:03
-	0	5509553.pn. and semi-additive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:03

-	1	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and semiadditive not (((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and semi-additive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:04
-	7	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and semi-additive) and steel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:22
-	0	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and (etched or etching or etches or etchant)) and semi-additive) and steel) and photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:23
-	117	((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and photoresist and steel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 12:23
-	1	(((((("glass transition temperature" or "T.sub.g") and (expansion or expansivity)) and polyimide) and photoresist and steel) and (semiadditive or semi-additive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 13:55
-	2	6287890.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 13:58
-	6	"wireless suspension blank" and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 13:59
-	14	"wireless suspension blank"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 14:04
-	68	("load beam" same (expansion or expansivity)) and ((disk or hard) adj1 drive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 14:06
-	37	("load beam" with (expansion or expansivity)) and ((disk or hard) adj1 drive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 14:07
-	5	((("load beam" with (expansion or expansivity)) and ((disk or hard) adj1 drive)) and polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/01 15:23